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**System On Chip (SoC)** integrates multiple functions of a computer or electronic system onto a single chip. Unlike traditional multi-chip solutions. SoCs combine a central

Details	
Product Status	Active
Architecture	MCU, FPGA
Core Processor	Dual ARM® Cortex®-A9 MPCore™ with CoreSight™
Flash Size	-
RAM Size	64KB
Peripherals	DMA, POR, WDT
Connectivity	CANbus, EBI/EMI, Ethernet, I <sup>2</sup> C, MMC/SD/SDIO, SPI, UART/USART, USB OTG
Speed	800MHz
Primary Attributes	FPGA - 25K Logic Elements
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	672-FBGA
Supplier Device Package	672-UBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/intel/5csema2u23i7n

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# **Cyclone V Device Overview**

The Cyclone® V devices are designed to simultaneously accommodate the shrinking power consumption, cost, and time-to-market requirements; and the increasing bandwidth requirements for high-volume and cost-sensitive applications.

Enhanced with integrated transceivers and hard memory controllers, the Cyclone V devices are suitable for applications in the industrial, wireless and wireline, military, and automotive markets.

## **Related Information**

Cyclone V Device Handbook: Known Issues

Lists the planned updates to the Cyclone V Device Handbook chapters.

# **Key Advantages of Cyclone V Devices**

Table 1. Key Advantages of the Cyclone V Device Family

Advantage	Supporting Feature
Lower power consumption	Built on TSMC's 28 nm low-power (28LP) process technology and includes an abundance of hard intellectual property (IP) blocks     Up to 40% lower power consumption than the previous generation device
Improved logic integration and differentiation capabilities	8-input adaptive logic module (ALM)     Up to 13.59 megabits (Mb) of embedded memory     Variable-precision digital signal processing (DSP) blocks
Increased bandwidth capacity	3.125 gigabits per second (Gbps) and 6.144 Gbps transceivers     Hard memory controllers
Hard processor system (HPS) with integrated Arm* Cortex*-A9 MPCore* processor	<ul> <li>Tight integration of a dual-core Arm Cortex-A9 MPCore processor, hard IP, and an FPGA in a single Cyclone V system-on-a-chip (SoC)</li> <li>Supports over 128 Gbps peak bandwidth with integrated data coherency between the processor and the FPGA fabric</li> </ul>
Lowest system cost	Requires only two core voltages to operate  Available in low-cost wirebond packaging  Includes innovative features such as Configuration via Protocol (CvP) and partial reconfiguration



# **Summary of Cyclone V Features**

**Summary of Features for Cyclone V Devices** Table 2.

Feature		Description		
Technology	<ul> <li>TSMC's 28-nm low-power (28LP) process technology</li> <li>1.1 V core voltage</li> </ul>			
Packaging	<ul> <li>Wirebond low-halogen packages</li> <li>Multiple device densities with compatible package footprints for seamless migration between different device densities</li> <li>RoHS-compliant and leaded<sup>(1)</sup>options</li> </ul>			
High-performance FPGA fabric	Enhanced 8-input ALM v	vith four registers		
Internal memory blocks	•	(b) memory blocks with soft error correction code (ECC) block (MLAB)—640-bit distributed LUTRAM where you can use up to 25% memory		
Embedded Hard IP blocks	Variable-precision DSP  • Native support for up to three signal processing precision levels (three 9 x 9, two 18 x 18, or one 27 x 27 multiplier) in the same variable-precision DSP block  • 64-bit accumulator and cascade  • Embedded internal coefficient memory  • Preadder/subtractor for improved efficiency			
	Memory controller	DDR3, DDR2, and LPDDR2 with 16 and 32 bit ECC support		
	Embedded transceiver I/O	PCI Express* (PCIe*) Gen2 and Gen1 (x1, x2, or x4) hard IP with multifunction support, endpoint, and root port		
Clock networks		ol clock network d peripheral clock networks are not used can be powered down to reduce dynamic power		
Phase-locked loops (PLLs)	<ul><li>Precision clock synth</li><li>Integer mode and from</li></ul>	esis, clock delay compensation, and zero delay buffering (ZDB) actional mode		
FPGA General-purpose I/Os (GPIOs)	400 MHz/800 Mbps 6     On-chip termination	cond (Mbps) LVDS receiver and 840 Mbps LVDS transmitter external memory interface (OCT) p to 16 mA drive strength		
Low-power high-speed serial interface	<ul> <li>614 Mbps to 6.144 Gbps integrated transceiver speed</li> <li>Transmit pre-emphasis and receiver equalization</li> <li>Dynamic partial reconfiguration of individual channels</li> </ul>			
HPS (Cyclone V SE, SX, and ST devices only)	<ul> <li>Single or dual-core Arm Cortex-A9 MPCore processor-up to 925 MHz maximum frequency with support for symmetric and asymmetric multiprocessing</li> <li>Interface peripherals—10/100/1000 Ethernet media access control (EMAC), USB 2.0 On-The-GO (OTG) controller, quad serial peripheral interface (QSPI) flash controller, NAND flash controller, Secure Digital/MultiMediaCard (SD/MMC) controller, UART, controller area network (CAN), serial peripheral interface (SPI), I<sup>2</sup>C interface, and up to 85 HPS GPIO interfaces</li> </ul>			
		-general-purpose timers, watchdog timers, direct memory access (DMA) iguration manager, and clock and reset managers ot ROM		
	·	continued		

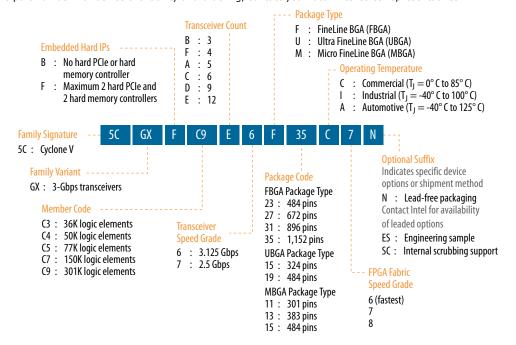
<sup>(1)</sup> Contact Intel for availability.



# **Available Options**

## Figure 2. Sample Ordering Code and Available Options for Cyclone V GX Devices

The SEU internal scrubbing feature is available for Cyclone V E, GX, SE, and SX devices with the "SC" suffix in the part number. For device availability and ordering, contact your local Intel sales representatives.



## **Maximum Resources**

**Table 6.** Maximum Resource Counts for Cyclone V GX Devices

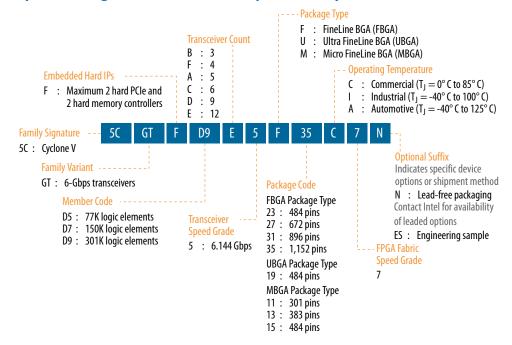
Resource		Member Code					
		С3	C4	<b>C5</b>	<b>C7</b>	С9	
Logic Elements (	(LE) (K)	36	50	77	150	301	
ALM		13,460	18,860	29,080	56,480	113,560	
Register		53,840	75,440	116,320	225,920	454,240	
Memory (Kb)	M10K	1,350	2,500	4,460	6,860	12,200	
	MLAB	182	424	424	836	1,717	
Variable-precision	n DSP Block	57	70	150	156	342	
18 x 18 Multiplie	er	114	140	300	312	684	
PLL		4	6	6	7	8	
3 Gbps Transceiver		3	6	6	9	12	
GPIO <sup>(4)</sup>		208	336	336	480	560	
	continued.					continued	

<sup>(4)</sup> The number of GPIOs does not include transceiver I/Os. In the Intel Quartus® Prime software, the number of user I/Os includes transceiver I/Os.



# **Available Options**

Figure 3. Sample Ordering Code and Available Options for Cyclone V GT Devices



## **Maximum Resources**

**Table 8.** Maximum Resource Counts for Cyclone V GT Devices

Resource			Member Code				
		D5	D7	D9			
Logic Elements (LE) (	K)	77	150	301			
ALM		29,080	56,480	113,560			
Register		116,320	225,920	454,240			
Memory (Kb)	M10K	4,460	6,860	12,200			
	MLAB	424	836	1,717			
Variable-precision DS	P Block	150	156	342			
18 x 18 Multiplier		300	312	684			
PLL		6	7	8			
6 Gbps Transceiver		6	9	12			
GPIO <sup>(5)</sup>		336	480	560			
LVDS	Transmitter	84	120	140			
	,	•		continued			

<sup>(5)</sup> The number of GPIOs does not include transceiver I/Os. In the Intel Quartus Prime software, the number of user I/Os includes transceiver I/Os.



# **Cyclone V SE**

This section provides the available options, maximum resource counts, and package plan for the Cyclone V SE devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the *Product Selector Guide*.

### **Related Information**

**Product Selector Guide** 

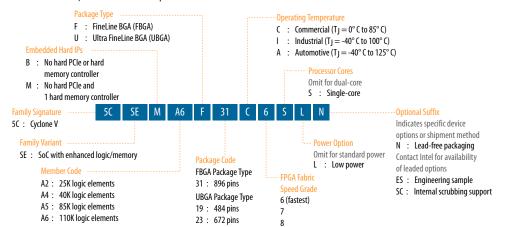
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## **Available Options**

## Figure 4. Sample Ordering Code and Available Options for Cyclone V SE Devices

The SEU internal scrubbing feature is available for Cyclone V E, GX, SE, and SX devices with the "SC" suffix in the part number. For device availability and ordering, contact your local Intel sales representatives.

Cyclone V SE and SX low-power devices (L power option) offer 30% static power reduction for devices with 25K LE and 40K LE, and 20% static power reduction for devices with 85K LE and 110K LE.





# **Maximum Resources**

Table 10. **Maximum Resource Counts for Cyclone V SE Devices** 

Res	ource		Me	ember Code	
		A2	A4	A5	A6
Logic Elements (	LE) (K)	25	40	85	110
ALM		9,430	15,880	32,070	41,910
Register		37,736	60,376	128,300	166,036
Memory (Kb)	M10K	1,400	2,700	3,970	5,570
	MLAB	138	231	480	621
Variable-precisio	n DSP Block	36	84	87	112
18 x 18 Multiplie	18 x 18 Multiplier		168	174	224
FPGA PLL		5	5	6	6
HPS PLL		3	3	3	3
FPGA GPIO		145	145	288	288
HPS I/O		181	181	181	181
LVDS	Transmitter	32	32	72	72
Receiver		37	37	72	72
FPGA Hard Memory Controller		1	1	1	1
HPS Hard Memory Controller		1	1	1	1
Arm Cortex-A9 M	1PCore Processor	Single- or dual- core	Single- or dual- core	Single- or dual-core	Single- or dual-core

## **Related Information**

True LVDS Buffers in Devices, I/O Features in Cyclone V Devices Provides the number of LVDS channels in each device package.

# **Package Plan**

#### **Package Plan for Cyclone V SE Devices** Table 11.

The HPS I/O counts are the number of I/Os in the HPS and does not correlate with the number of HPS-specific I/O pins in the FPGA. Each HPS-specific pin in the FPGA may be mapped to several HPS I/Os.

Member Code	U484 (19 mm)				F896 (31 mm)	
	FPGA GPIO	HPS I/O	FPGA GPIO	HPS I/O	FPGA GPIO	HPS I/O
A2	66	151	145	181	_	_
A4	66	151	145	181	_	_
A5	66	151	145	181	288	181
A6	66	151	145	181	288	181



# **Cyclone V SX**

This section provides the available options, maximum resource counts, and package plan for the Cyclone V SX devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the *Product Selector Guide*.

### **Related Information**

### **Product Selector Guide**

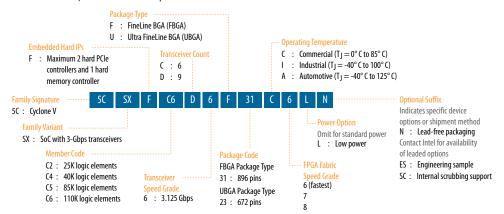
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## **Available Options**

## Figure 5. Sample Ordering Code and Available Options for Cyclone V SX Devices

The SEU internal scrubbing feature is available for Cyclone V E, GX, SE, and SX devices with the "SC" suffix in the part number. For device availability and ordering, contact your local Intel sales representatives.

Cyclone V SE and SX low-power devices (L power option) offer 30% static power reduction for devices with 25K LE and 40K LE, and 20% static power reduction for devices with 85K LE and 110K LE.



### **Maximum Resources**

**Table 12.** Maximum Resource Counts for Cyclone V SX Devices

Resource		Member Code				
		C2	C4	C5	C6	
Logic Elements (LE) (K)		25	40	85	110	
ALM		9,430	15,880	32,070	41,910	
Register		37,736	60,376	128,300	166,036	
Memory (Kb)	M10K	1,400	2,700	3,970	5,570	
	MLAB	138	231	480	621	
Variable-precision [	DSP Block	36	84	87	112	
18 x 18 Multiplier		72	168	174	224	
FPGA PLL		5	5	6	6	
					continued	



Resource		Member Code				
		C2	C4	C5	C6	
HPS PLL		3	3	3	3	
3 Gbps Transceiver		6	6	9	9	
FPGA GPIO (8)		145	145	288	288	
HPS I/O	HPS I/O		181	181	181	
LVDS	Transmitter	32	32	72	72	
	Receiver		37	72	72	
PCIe Hard IP Block		2	2	2 (9)	2 (9)	
FPGA Hard Memory Controller		1	1	1	1	
HPS Hard Memory Controller		1	1	1	1	
Arm Cortex-A9 MP0	Core Processor	Dual-core	Dual-core	Dual-core	Dual-core	

## **Related Information**

True LVDS Buffers in Devices, I/O Features in Cyclone V Devices

Provides the number of LVDS channels in each device package.

## **Package Plan**

**Table 13.** Package Plan for Cyclone V SX Devices

The HPS I/O counts are the number of I/Os in the HPS and does not correlate with the number of HPS-specific I/O pins in the FPGA. Each HPS-specific pin in the FPGA may be mapped to several HPS I/Os.

Member Code	U672 (23 mm)			F896 (31 mm)		
	FPGA GPIO	HPS I/O	XCVR	FPGA GPIO	HPS I/O	XCVR
C2	145	181	6	_	_	_
C4	145	181	6	_	_	_
C5	145	181	6	288	181	9
C6	145	181	6	288	181	9

# **Cyclone V ST**

This section provides the available options, maximum resource counts, and package plan for the Cyclone V ST devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the *Product Selector Guide*.

<sup>(8)</sup> The number of GPIOs does not include transceiver I/Os. In the Intel Quartus Prime software, the number of user I/Os includes transceiver I/Os.

<sup>(9) 1</sup> PCIe Hard IP Block in U672 package.



Table 16. Variable-Precision DSP Block Configurations for Cyclone V Devices

Usage Example	Multiplier Size (Bit)	DSP Block Resource
Low precision fixed point for video applications	Three 9 x 9	1
Medium precision fixed point in FIR filters	Two 18 x 18	1
FIR filters and general DSP usage	Two 18 x 18 with accumulate	1
High precision fixed- or floating-point implementations	One 27 x 27 with accumulate	1

You can configure each DSP block during compilation as independent three 9  $\times$  9, two 18  $\times$  18, or one 27  $\times$  27 multipliers. With a dedicated 64 bit cascade bus, you can cascade multiple variable-precision DSP blocks to implement even higher precision DSP functions efficiently.

**Table 17.** Number of Multipliers in Cyclone V Devices

The table lists the variable-precision DSP resources by bit precision for each Cyclone V device.

Variant	Code p	Variable- precision DSP Block	Independent Input and Output Multiplications Operator			18 x 18 Multiplier	18 x 18 Multiplier Adder
		DSP Block	9 x 9 Multiplier	18 x 18 Multiplier	27 x 27 Multiplier	Adder Mode	Summed with 36 bit Input
Cyclone V E	A2	25	75	50	25	25	25
	A4	66	198	132	66	66	66
	A5	150	450	300	150	150	150
	A7	156	468	312	156	156	156
	A9	342	1,026	684	342	342	342
Cyclone V	C3	57	171	114	57	57	57
GX	C4	70	210	140	70	70	70
	C5	150	450	300	150	150	150
	C7	156	468	312	156	156	156
	C9	342	1,026	684	342	342	342
Cyclone V GT	D5	150	450	300	150	150	150
	D7	156	468	312	156	156	156
	D9	342	1,026	684	342	342	342
Cyclone V SE	A2	36	108	72	36	36	36
	A4	84	252	168	84	84	84
	A5	87	261	174	87	87	87
	A6	112	336	224	112	112	112
Cyclone V SX	C2	36	108	72	36	36	36
	C4	84	252	168	84	84	84
	C5	87	261	174	87	87	87
							continued



#### **PLL Features**

The PLLs in the Cyclone V devices support the following features:

- Frequency synthesis
- On-chip clock deskew
- Jitter attenuation
- Programmable output clock duty cycles
- PLL cascading
- Reference clock switchover
- Programmable bandwidth
- User-mode reconfiguration of PLLs
- Low power mode for each fractional PLL
- Dynamic phase shift
- Direct, source synchronous, zero delay buffer, external feedback, and LVDS compensation modes

#### **Fractional PLL**

In addition to integer PLLs, the Cyclone V devices use a fractional PLL architecture. The devices have up to eight PLLs, each with nine output counters. You can use the output counters to reduce PLL usage in two ways:

- Reduce the number of oscillators that are required on your board by using fractional PLLs
- Reduce the number of clock pins that are used in the device by synthesizing multiple clock frequencies from a single reference clock source

If you use the fractional PLL mode, you can use the PLLs for precision fractional-N frequency synthesis—removing the need for off-chip reference clock sources in your design.

The transceiver fractional PLLs that are not used by the transceiver I/Os can be used as general purpose fractional PLLs by the FPGA fabric.

# FPGA General Purpose I/O

Cyclone V devices offer highly configurable GPIOs. The following list describes the features of the GPIOs:

- Programmable bus hold and weak pull-up
- $\bullet$  LVDS output buffer with programmable differential output voltage (V $_{\text{OD}}$  ) and programmable pre-emphasis
- ullet On-chip parallel termination (R<sub>T</sub> OCT) for all I/O banks with OCT calibration to limit the termination impedance variation
- On-chip dynamic termination that has the ability to swap between series and parallel termination, depending on whether there is read or write on a common bus for signal integrity
- Easy timing closure support using the hard read FIFO in the input register path, and delay-locked loop (DLL) delay chain with fine and coarse architecture



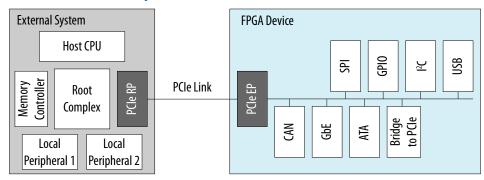
## PCIe Gen1 and Gen2 Hard IP

Cyclone V GX, GT, SX, and ST devices contain PCIe hard IP that is designed for performance and ease-of-use. The PCIe hard IP consists of the MAC, data link, and transaction layers.

The PCIe hard IP supports PCIe Gen2 and Gen1 end point and root port for up to x4 lane configuration. The PCIe Gen2 x4 support is PCIe-compatible.

The PCIe endpoint support includes multifunction support for up to eight functions, as shown in the following figure. The integrated multifunction support reduces the FPGA logic requirements by up to 20,000 LEs for PCIe designs that require multiple peripherals.

Figure 9. PCIe Multifunction for Cyclone V Devices



The Cyclone V PCIe hard IP operates independently from the core logic. This independent operation allows the PCIe link to wake up and complete link training in less than 100 ms while the Cyclone V device completes loading the programming file for the rest of the device.

In addition, the PCIe hard IP in the Cyclone V device provides improved end-to-end datapath protection using ECC.

# **External Memory Interface**

This section provides an overview of the external memory interface in Cyclone V devices.

# **Hard and Soft Memory Controllers**

Cyclone V devices support up to two hard memory controllers for DDR3, DDR2, and LPDDR2 SDRAM devices. Each controller supports 8 to 32 bit components of up to 4 gigabits (Gb) in density with two chip selects and optional ECC. For the Cyclone V SoC devices, an additional hard memory controller in the HPS supports DDR3, DDR2, and LPDDR2 SDRAM devices.

All Cyclone V devices support soft memory controllers for DDR3, DDR2, and LPDDR2 SDRAM devices for maximum flexibility.



# **External Memory Performance**

## Table 20. External Memory Interface Performance in Cyclone V Devices

The maximum and minimum operating frequencies depend on the memory interface standards and the supported delay-locked loop (DLL) frequency listed in the device datasheet.

Interface	Voltage	Maximum Fre	Minimum Frequency	
	(V)	Hard Controller	Soft Controller	(MHz)
DDR3 SDRAM	1.5	400	303	303
	1.35	400	303	303
DDR2 SDRAM	1.8	400	300	167
LPDDR2 SDRAM	1.2	333	300	167

#### **Related Information**

## External Memory Interface Spec Estimator

For the latest information and to estimate the external memory system performance specification, use Intel's External Memory Interface Spec Estimator tool.

# **HPS External Memory Performance**

## **Table 21. HPS External Memory Interface Performance**

The hard processor system (HPS) is available in Cyclone V SoC devices only.

Interface	Voltage (V)	HPS Hard Controller (MHz)
DDR3 SDRAM	1.5	400
	1.35	400
DDR2 SDRAM	1.8	400
LPDDR2 SDRAM	1.2	333

### **Related Information**

## External Memory Interface Spec Estimator

For the latest information and to estimate the external memory system performance specification, use Intel's External Memory Interface Spec Estimator tool.

## **Low-Power Serial Transceivers**

Cyclone V devices deliver the industry's lowest power 6.144 Gbps transceivers at an estimated 88 mW maximum power consumption per channel. Cyclone V transceivers are designed to be compliant with a wide range of protocols and data rates.

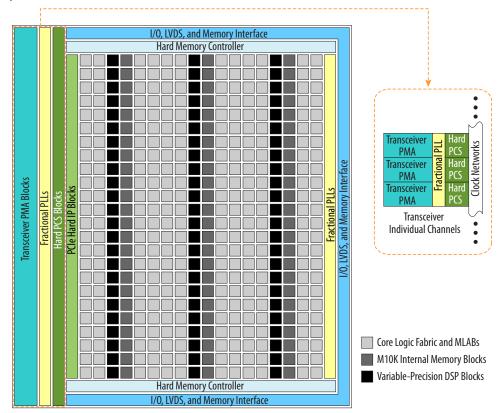
## **Transceiver Channels**

The transceivers are positioned on the left outer edge of the device. The transceiver channels consist of the physical medium attachment (PMA), physical coding sublayer (PCS), and clock networks.



Figure 10. Device Chip Overview for Cyclone V GX and GT Devices

The figure shows a Cyclone V FPGA with transceivers. Different Cyclone V devices may have a different floorplans than the one shown here.



## **PMA Features**

To prevent core and I/O noise from coupling into the transceivers, the PMA block is isolated from the rest of the chip—ensuring optimal signal integrity. For the transceivers, you can use the channel PLL of an unused receiver PMA as an additional transmit PLL.

Table 22. PMA Features of the Transceivers in Cyclone V Devices

Features	Capability		
Backplane support	Driving capability up to 6.144 Gbps		
PLL-based clock recovery	Superior jitter tolerance		
Programmable deserialization and word alignment	Flexible deserialization width and configurable word alignment pattern		
Equalization and pre-emphasis	<ul> <li>Up to 14.37 dB of pre-emphasis and up to 4.7 dB of equalization</li> <li>No decision feedback equalizer (DFE)</li> </ul>		
Ring oscillator transmit PLLs	614 Mbps to 6.144 Gbps		
Input reference clock range	20 MHz to 400 MHz		
Transceiver dynamic reconfiguration	Allows the reconfiguration of a single channel without affecting the operation of other channels		



## **PCS Features**

The Cyclone V core logic connects to the PCS through an 8, 10, 16, 20, 32, or 40 bit interface, depending on the transceiver data rate and protocol. Cyclone V devices contain PCS hard IP to support PCIe Gen1 and Gen2, Gbps Ethernet (GbE), Serial RapidIO<sup>®</sup> (SRIO), and Common Public Radio Interface (CPRI).

Most of the standard and proprietary protocols from 614 Mbps to 6.144 Gbps are supported.

**Table 23.** Transceiver PCS Features for Cyclone V Devices

PCS Support	Data Rates (Gbps)	Transmitter Data Path Feature	Receiver Data Path Feature		
3-Gbps and 6-Gbps Basic	0.614 to 6.144	<ul> <li>Phase compensation FIFO</li> <li>Byte serializer</li> <li>8B/10B encoder</li> <li>Transmitter bit-slip</li> </ul>	<ul> <li>Word aligner</li> <li>Deskew FIFO</li> <li>Rate-match FIFO</li> <li>8B/10B decoder</li> <li>Byte deserializer</li> <li>Byte ordering</li> <li>Receiver phase compensation FIFO</li> </ul>		
PCIe Gen1 (x1, x2, x4)	2.5 and 5.0	Dedicated PCIe PHY IP core     PIPE 2.0 interface to the core logic	Dedicated PCIe PHY IP core     PIPE 2.0 interface to the core logic		
PCIe Gen2 ( x1, x2, x4) <sup>(12)</sup>		logic	logic		
GbE	1.25	Custom PHY IP core with preset feature     GbE transmitter synchronization state machine	Custom PHY IP core with preset feature     GbE receiver synchronization state machine		
XAUI (13)	3.125	Dedicated XAUI PHY IP core	Dedicated XAUI PHY IP core		
HiGig	3.75	<ul> <li>XAUI synchronization state machine for bonding four channels</li> </ul>	XAUI synchronization state machine for realigning four channels		
SRIO 1.3 and 2.1	1.25 to 3.125	Custom PHY IP core with preset feature     SRIO version 2.1-compliant x2 and x4 channel bonding	Custom PHY IP core with preset feature     SRIO version 2.1-compliant x2 and x4 deskew state machine		
SDI, SD/HD, and 3G-SDI	0.27 <sup>(14)</sup> , 1.485, and 2.97	Custom PHY IP core with preset feature	Custom PHY IP core with preset feature		
JESD204A	0.3125 <sup>(15)</sup> to 3.125				
	,		continued		

<sup>(12)</sup> PCIe Gen2 is supported for Cyclone V GT and ST devices. The PCIe Gen2 x4 support is PCIe-compatible.

<sup>(13)</sup> XAUI is supported through the soft PCS.

 $<sup>^{(14)}</sup>$  The 0.27-Gbps data rate is supported using oversampling user logic that you must implement in the FPGA fabric.

<sup>(15)</sup> The 0.3125-Gbps data rate is supported using oversampling user logic that you must implement in the FPGA fabric.

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Note:

Although the FPGA fabric and HPS are on separate power domains, the HPS must remain powered up during operation while the FPGA fabric can be powered up or down as required.

### **Related Information**

Cyclone V Device Family Pin Connection Guidelines

Provides detailed information about power supply pin connection guidelines and power regulator sharing.

# **Hardware and Software Development**

For hardware development, you can configure the HPS and connect your soft logic in the FPGA fabric to the HPS interfaces using the Platform Designer (Standard) system integration tool in the Intel Quartus Prime software.

For software development, the Arm-based SoC devices inherit the rich software development ecosystem available for the Arm Cortex-A9 MPCore processor. The software development process for Intel SoCs follows the same steps as those for other SoC devices from other manufacturers. Support for Linux, VxWorks<sup>®</sup>, and other operating systems is available for the SoCs. For more information on the operating systems support availability, contact the Intel sales team.

You can begin device-specific firmware and software development on the Intel SoC Virtual Target. The Virtual Target is a fast PC-based functional simulation of a target development system—a model of a complete development board that runs on a PC. The Virtual Target enables the development of device-specific production software that can run unmodified on actual hardware.

### **Related Information**

International Altera Sales Support Offices

# **Dynamic and Partial Reconfiguration**

The Cyclone V devices support dynamic reconfiguration and partial reconfiguration.

## **Dynamic Reconfiguration**

The dynamic reconfiguration feature allows you to dynamically change the transceiver data rates, PMA settings, or protocols of a channel, without affecting data transfer on adjacent channels. This feature is ideal for applications that require on-the-fly multiprotocol or multirate support. You can reconfigure the PMA and PCS blocks with dynamic reconfiguration.

# **Partial Reconfiguration**

Note:

The partial reconfiguration feature is available for Cyclone V E, GX, SE, and SX devices with the "SC" suffix in the part number. For device availability and ordering, contact your local Intel sales representatives.

Partial reconfiguration allows you to reconfigure part of the device while other sections of the device remain operational. This capability is important in systems with critical uptime requirements because it allows you to make updates or adjust functionality without disrupting services.



Apart from lowering cost and power consumption, partial reconfiguration increases the effective logic density of the device because placing device functions that do not operate simultaneously is not necessary. Instead, you can store these functions in external memory and load them whenever the functions are required. This capability reduces the size of the device because it allows multiple applications on a single device—saving the board space and reducing the power consumption.

Intel simplifies the time-intensive task of partial reconfiguration by building this capability on top of the proven incremental compile and design flow in the Intel Quartus Prime design software. With the Intel solution, you do not need to know all the intricate device architecture details to perform a partial reconfiguration.

Partial reconfiguration is supported through the FPP x16 configuration interface. You can seamlessly use partial reconfiguration in tandem with dynamic reconfiguration to enable simultaneous partial reconfiguration of both the device core and transceivers.

# **Enhanced Configuration and Configuration via Protocol**

Cyclone V devices support  $1.8\ V$ ,  $2.5\ V$ ,  $3.0\ V$ , and  $3.3\ V$  programming voltages and several configuration schemes.

Table 24. Configuration Schemes and Features Supported by Cyclone V Devices

Mode	Data Width	Max Clock Rate (MHz)	Max Data Rate (Mbps)	Decompressi on	Design Security	Partial Reconfigurat ion <sup>(18)</sup>	Remote System Update
AS through the EPCS and EPCQ serial configuration device	1 bit, 4 bits	100	_	Yes	Yes	_	Yes
PS through CPLD or external microcontroller	1 bit	125	125	Yes	Yes	_	_
FPP	8 bits	125	_	Yes	Yes	_	Parallel flash
	16 bits	125	_	Yes	Yes	Yes	loader
CvP (PCIe)	x1, x2, and x4 lanes	_	_	Yes	Yes	Yes	_
JTAG	1 bit	33	33	_	_	_	_

Instead of using an external flash or ROM, you can configure the Cyclone V devices through PCIe using CvP. The CvP mode offers the fastest configuration rate and flexibility with the easy-to-use PCIe hard IP block interface. The Cyclone V CvP implementation conforms to the PCIe 100 ms power-up-to-active time requirement.

## **Related Information**

Configuration via Protocol (CvP) Implementation in Intel FPGAs User Guide Provides more information about CvP.

<sup>(18)</sup> The partial reconfiguration feature is available for Cyclone V E, GX, SE, and SX devices with the "SC" suffix in the part number. For device availability and ordering, contact your local Intel sales representatives.



Date	Version	Changes
		<ul> <li>Updated MLAB RAM Bit (Kb) in Embedded Memory Capacity and Distribution in Cyclone V Devices table as follows:         <ul> <li>Cyclone V GX C3: Updated from 181 to 182</li> <li>Cyclone V GX C4: Updated from 295 to 424</li> </ul> </li> <li>Updated Total RAM Bit (Kb) in Embedded Memory Capacity and Distribution in Cyclone V Devices table as follows:         <ul> <li>Cyclone V GX C3: Updated from 1,531 to 1,532</li> <li>Cyclone V GX C4: Updated from 2,795 to 2,924</li> </ul> </li> <li>Updated MLAB Block count in Embedded Memory Capacity and Distribution in Cyclone V Devices table as follows:         <ul> <li>Cyclone V GX C4: Updated from 472 to 678</li> <li>Cyclone V GX C5: Updated from 679 to 678</li> </ul> </li> </ul>
March 2015	2015.03.31	Added internal scrubbing feature under configuration in Summary of Features for Cyclone V Devices table.     Added optional suffix "SC: Internal scrubbing support" to the following diagrams:     — Sample Ordering Code and Available Options for Cyclone V E Devices     — Sample Ordering Code and Available Options for Cyclone V GX Devices     — Sample Ordering Code and Available Options for Cyclone V SE Devices     — Sample Ordering Code and Available Options for Cyclone V SX Devices
January 2015	2015.01.23	<ul> <li>Updated Sample Ordering Code and Available Options for Cyclone V ST Devices figure because Cyclone V ST devices are only available in I temperature grade and -7 speed grade.</li> <li>Operating Temperature: Removed C and A temperature grades</li> <li>FPGA Fabric Speed Grade: Removed -6 and -8 speed grades</li> <li>Updated the transceiver specification for Cyclone V ST from 5 Gbps to 6.144 Gbps:</li> <li>Device Variants for the Cyclone V Device Family table</li> <li>Sample Ordering Code and Available Options for Cyclone V ST Devices figure</li> <li>Maximum Resource Counts for Cyclone V ST Devices</li> <li>Updated Maximum Resource Counts for Cyclone V GX Devices table for Cyclone V GX G3 devices.</li> <li>Logic elements (LE) (K): Updated from 35.7 to 35.5</li> <li>Variable-precision DSP block: Updated from 51 to 57</li> <li>18 x 18 multiplier: Updated from 102 to 114</li> <li>Updated Number of Multipliers in Cyclone V Devices table for Cyclone V GX G3 devices.</li> <li>Variableprecision DSP Block: Updated from 51 to 57</li> <li>9 x 9 Multiplier: Updated from 153 to 171</li> <li>18 x 18 Multiplier: Updated from 102 to 114</li> <li>27 x 27 Multiplier: Updated from 51 to 57</li> <li>18 x 18 Multiplier Adder Mode: Updated from 51 to 57</li> <li>18 x 18 Multiplier Adder Summed with 36 bit Input: Updated from 51 to 57</li> <li>Updated Embedded Memory Capacity and Distribution in Cyclone V Devices table for Cyclone V GX G3 devices.</li> <li>M10K Block: Updated from 119 to 135</li> <li>M10K RAM bit (Kb): Updated from 1,190 to 1,350</li> <li>MLAB BAM bit (Kb): Updated from 159 to 181</li> <li>Total RAM bit (Kb): Updated from 1,349 to 1,531</li> </ul>
October 2014	2014.10.06	Added a footnote to the "Transceiver PCS Features for Cyclone V Devices" table to show that PCIe Gen2 is supported for Cyclone V GT and ST devices.
		continued



Date	Version	Changes
		<ul> <li>Updated HPS I/O for U484 (19 mm) in Table 11 with '151' for A2, A4, A5 and A6.</li> <li>Updated Memory (Kb) for Maximum Resource Counts for Cyclone V SE A4 and A6, SX C4 and C6, ST D6 devices.</li> <li>Updated FPGA PLL for Maximum Resource Counts for Cyclone V SE A2, SX C2, devices.</li> <li>Removed '36 x 36' from the Variable-Precision DSP Block.</li> <li>Updated Variable-precision DSP Blocks and 18 x 18 Multiplier for Maximum Resource Counts for Cyclone V SX C4 device.</li> <li>Updated the HPS I/O counts for Cyclone V SE, SX, and ST devices.</li> <li>Updated Figure 7 which shows the I/O vertical migration table.</li> <li>Updated Table 17 for Cyclone V SX C4 device.</li> <li>Updated Embedded Memory Capacity and Distribution table for Cyclone V SE A4 and A6, SX C4 and C6, ST D6 devices.</li> <li>Removed 'Counter reconfiguration' from the PLL Features.</li> <li>Updated Low-Power Serial Transceivers by replacing 5 Gbps with 6.144 Gbps.</li> <li>Removed 'Distributed Memory' symbol.</li> <li>Updated the Capability in Table 22 of Backplane support to '6.144 Gbps'.</li> <li>Updated the PCS Support in Table 23 from 5 Gbps to '6 Gbps'.</li> <li>Updated the Data Rates (Gbps) in Table 23 of 3 Gbps and 6 Gbps Basic to '6.144 Gbps'.</li> <li>Updated the Data Rates (Gbps) in Table 23 of CPRI 4.1 to '6.144 Gbps'.</li> <li>Clarified that partial reconfiguration is an advanced feature. Contact Altera for support of the feature.</li> </ul>
December 2012	2012.12.28	<ul> <li>Updated the pin counts for the MBGA packages.</li> <li>Updated the GPIO and transceiver counts for the MBGA packages.</li> <li>Updated the GPIO counts for the U484 package of the Cyclone V E A9, GX C9, and GT D9 devices.</li> <li>Updated the vertical migration table for vertical migration of the U484 packages.</li> <li>Updated the MLAB supported programmable widths at 32 bits depth.</li> </ul>
November 2012	2012.11.19	<ul> <li>Added new MBGA packages and additional U484 packages for Cyclone V E, GX, and GT.</li> <li>Added ordering code for five-transceiver devices for Cyclone V GT and ST.</li> <li>Updated the vertical migration table to add MBGA packages.</li> <li>Added performance information for HPS memory controller.</li> <li>Removed DDR3U support.</li> <li>Updated Cyclone V ST speed grade information.</li> <li>Added information on maximum transceiver channel usage restrictions for PCI Gen2 and CPRI at 4.9152 Gbps transmit jitter compliance.</li> <li>Added note on the differences between GPIO reported in Overview with User I/O numbers shown in the Quartus II software.</li> <li>Updated template.</li> </ul>
July 2012	2.1	Added support for PCIe Gen2 x4 lane configuration (PCIe-compatible)
June 2012	2.0	<ul> <li>Restructured the document.</li> <li>Added the "Embedded Memory Capacity" and "Embedded Memory Configurations" sections.</li> <li>Added Table 1, Table 3, Table 16, Table 19, and Table 20.</li> <li>Updated Table 2, Table 4, Table 5, Table 6, Table 7, Table 8, Table 9, Table 10, Table 11, Table 12, Table 13, Table 14, Table 17, and Table 18.</li> </ul>

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Date	Version	Changes
		<ul> <li>Updated Figure 1, Figure 2, Figure 3, Figure 4, Figure 5, Figure 6, and Figure 10.</li> <li>Updated the "FPGA Configuration and Processor Booting" and "Hardware and Software Development" sections.</li> <li>Text edits throughout the document.</li> </ul>
February 2012	1.2	<ul> <li>Updated Table 1-2, Table 1-3, and Table 1-6.</li> <li>Updated "Cyclone V Family Plan" on page 1-4 and "Clock Networks and PLL Clock Sources" on page 1-15.</li> <li>Updated Figure 1-1 and Figure 1-6.</li> </ul>
November 2011	1.1	<ul> <li>Updated Table 1-1, Table 1-2, Table 1-3, Table 1-4, Table 1-5, and Table 1-6.</li> <li>Updated Figure 1-4, Figure 1-5, Figure 1-6, Figure 1-7, and Figure 1-8.</li> <li>Updated "System Peripherals" on page 1-18, "HPS-FPGA AXI Bridges" on page 1-19, "HPS SDRAM Controller Subsystem" on page 1-19, "FPGA Configuration and Processor Booting" on page 1-19, and "Hardware and Software Development" on page 1-20.</li> <li>Minor text edits.</li> </ul>
October 2011	1.0	Initial release.